# UNISONIC TECHNOLOGIES CO., LTD

4N55-LC **Power MOSFET** 

# 4A, 550V N-CHANNEL **POWER MOSFET**

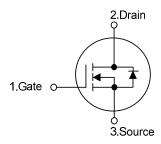
#### DESCRIPTION

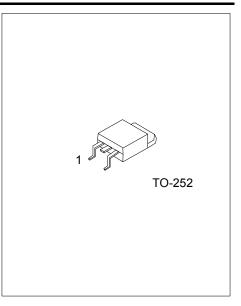
The UTC 4N55-LC is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

#### **FEATURES**

- \*  $R_{DS(ON)}$  < 2.5 $\Omega$  @  $V_{GS}$  = 10V,  $I_D$  = 2.0A
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

#### **SYMBOL**

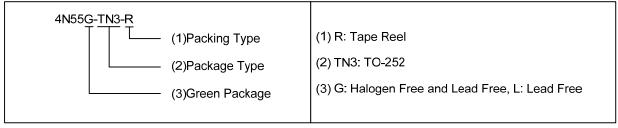




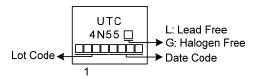
#### ORDERING INFORMATION

Ordering Number		Doolsono	Pin	Assignm	Dooking		
Lead Free	Halogen Free	Package	1	2	3	Packing	
4N55L-TN3-R	4N55G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### **MARKING**



www.unisonic.com.tw 1 of 7 4N55-LC Power MOSFET

# ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	550	V
Gate-Source Voltage	$V_{GSS}$	±30	V
Continuous Drain Current	I <sub>D</sub>	4	Α
Pulsed Drain Current (Note 2)	I <sub>DM</sub>	8	Α
Avalanche Energy Single Pulsed (Note 3)	E <sub>AS</sub>	140	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	3	V/ns
Power Dissipation	P <sub>D</sub>	52	W
Junction Temperature	TJ	+150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ <b>+</b> 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH,  $I_{AS}$  = 5.3A,  $V_{DD}$  = 50V,  $R_{G}$  = 25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4.  $I_{SD} \le 4.0A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### ■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	110	°C/W	
Junction to Case	$\theta_{ m JC}$	2.5 (Note)	°C/W	

Note: The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

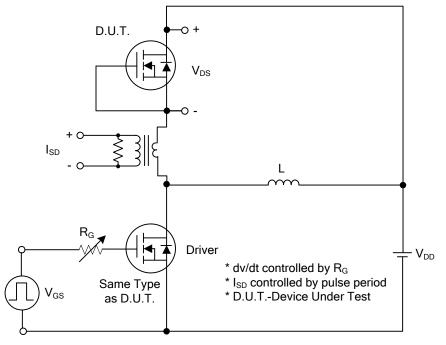
# ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 250\mu A$	550			V	
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS} = 550V, V_{GS} = 0V$			10	μΑ	
Gate- Source Leakage Current	Forward	- I <sub>GSS</sub>	$V_{GS} = 30V, V_{DS} = 0V$			100	nA	
	Reverse	IGSS	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS} = 10V, I_D = 2.0A$			2.5	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance	nput Capacitance				363		pF	
Output Capacitance		Coss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0 MHz		50		pF	
Reverse Transfer Capacitance		C <sub>RSS</sub>			6		pF	
SWITCHING CHARACTERISTIC	S							
Total Gate Charge (Note 1)		$Q_{G}$	V <sub>DS</sub> =100V, V <sub>GS</sub> =10V, I <sub>D</sub> =4.0A,		13		nC	
Gate-Source Charge		$Q_GS$	I <sub>D</sub> =1mA (Note 1, 2)		5.4		nC	
Gate-Drain Charge		$Q_{GD}$	ID-IIIA (Note 1, 2)		3		nC	
Turn-On Delay Time (Note 1)		t <sub>D(ON)</sub>			6.4		ns	
Turn-On Rise Time		t <sub>R</sub>	$V_{DD}$ =100V, $V_{GS}$ =10V, $I_{D}$ =4.0A,		17		ns	
Turn-Off Delay Time		t <sub>D(OFF)</sub>	$R_G = 25\Omega$ (Note 1, 2)		25.6		ns	
Turn-Off Fall Time		t <sub>F</sub>			53.5		ns	
DRAIN-SOURCE DIODE CHARA	CTERISTIC	CS AND MA	XIMUM RATINGS					
Maximum Body-Diode Continuous Current		Is				4	Α	
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				8	Α	
Drain-Source Diode Forward Voltage		$V_{SD}$	I <sub>S</sub> =4.0A , V <sub>GS</sub> =0V			1.4	V	
Body Diode Reverse Recovery Time		t <sub>rr</sub>	  I <sub>S</sub> =4.0A , V <sub>GS</sub> =0V di/dt=100A/μs		240		ns	
Body Diode Reverse Recovery Charge		$Q_{rr}$	115-4.0A , VGS-0V αι/αι-100A/μS		1.4		μC	

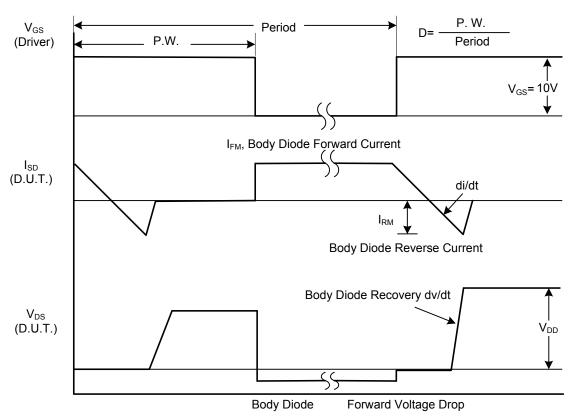
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

#### **■ TEST CIRCUITS AND WAVEFORMS**

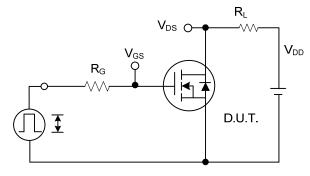


Peak Diode Recovery dv/dt Test Circuit

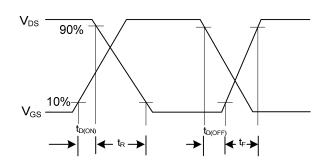


Peak Diode Recovery dv/dt Waveforms

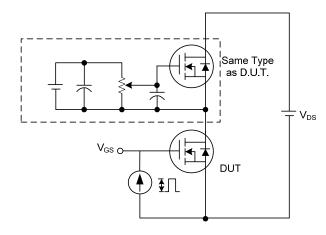
# **■ TEST CIRCUITS AND WAVEFORMS**



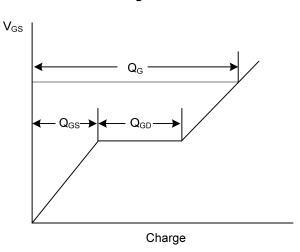
**Switching Test Circuit** 



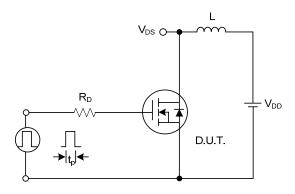
**Switching Waveforms** 



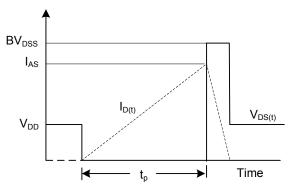
**Gate Charge Test Circuit** 



**Gate Charge Waveform** 

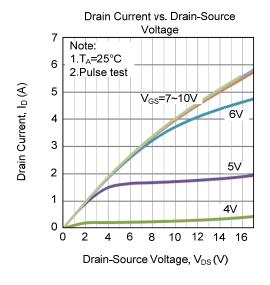


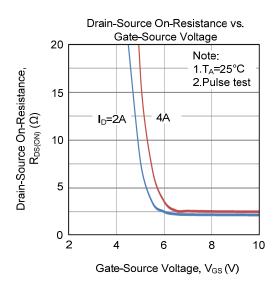
**Unclamped Inductive Switching Test Circuit** 

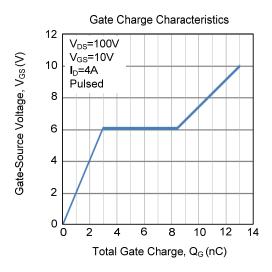


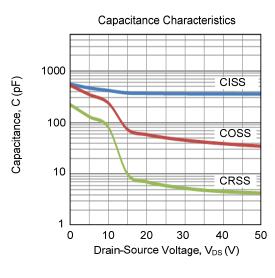
**Unclamped Inductive Switching Waveforms** 

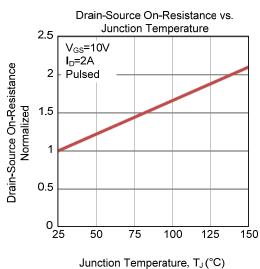
#### **■ TYPICAL CHARACTERISTICS**

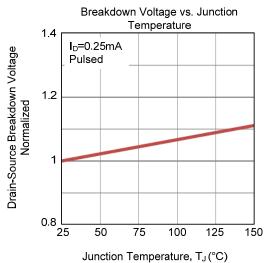




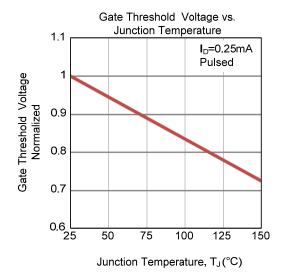


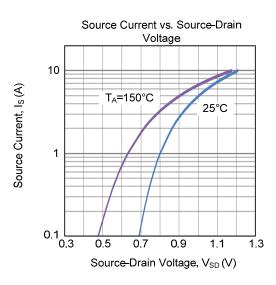


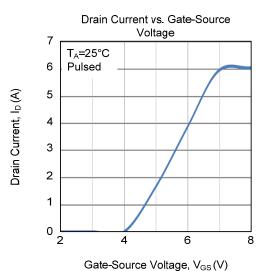


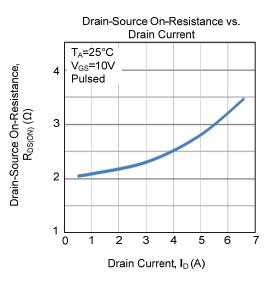


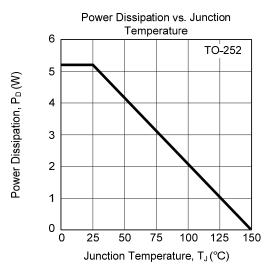
# **■ TYPICAL CHARACTERISTICS (Cont.)**

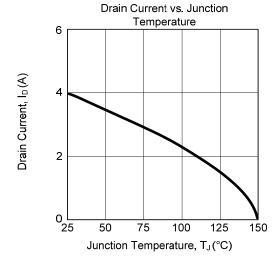




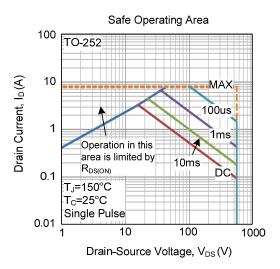








# **■ TYPICAL CHARACTERISTICS (Cont.)**



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.